

## STM32WB5MMG module product errata

## Applicability

This document applies to the STM32WB5MMG module product.

It gives a summary and a description of module-specific errata, with respect to the module product datasheet DS13252 available on [www.st.com](http://www.st.com).

Deviation of the real module product properties from the intended module product properties is considered to be a module product limitation. Deviation of the description in the module product datasheet from the intended module product properties is considered to be a documentation erratum. The terms “*erratum*” and “*errata*” apply both to limitations and documentation errata.

The module integrates the STM32WB55VG microcontroller with Arm® core. For errata of the microcontroller device, refer to its errata sheet ES0394 on [www.st.com](http://www.st.com).

*Note:* Arm is a registered trademark of Arm Limited (or its subsidiaries) in the US and/or elsewhere.



**Table 1. Module variants**

Reference	Module variant
STM32WB5MMG	Y
	X

## 1 Summary of module-specific errata

The following table gives a quick reference to the documentation errata.

**Table 2. Summary of module-specific documentation errata**

Function	Section	Documentation erratum
System	2.1.1	LSE frequency shift
	2.1.2	PB0 and PB1 swapped in datasheet pinning

## 2 Description of module-specific errata

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The following sections describe module-specific errata of the module product.

### 2.1 System

#### 2.1.1 LSE frequency shift

##### Description

Some versions of the datasheet omit the information that the LSE frequency of the microcontroller mounted on the module is shifted to 32774 Hz (+183ppm), versus the nominal 32768 Hz. The application software must reflect this module characteristic if the on-chip peripherals such as RTC and BLE use LSE as a clock reference.

This is a documentation issue rather than a product limitation.

##### Workaround

No application workaround is applicable provided that the application already takes the frequency shift into account.

#### 2.1.2 PB0 and PB1 swapped in datasheet pinning

##### Description

In some datasheet versions pinning has incorrect assignments of PB0 and PB1. The correct assignment is PB1 on 43 and PB0 on 44.

##### Workaround

None.

Assignment in CubeMx is correct.

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## Revision history

**Table 3. Document revision history**

Date	Version	Changes
09-Mar-2020	1	Initial release.
16-Dec-2021	2	Added documentation erratum <a href="#">LSE frequency shift</a> .
24-Feb-2023	3	Added: <ul style="list-style-type: none"><li>• <a href="#">Section Important security notice</a></li><li>• <a href="#">Documentation erratum Section 2.1.2 PB0 and PB1 swapped in datasheet pinning</a></li></ul>

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